

UT Inner-backplane Mapping

Zishuo Yang

Aug 3rd, 2017

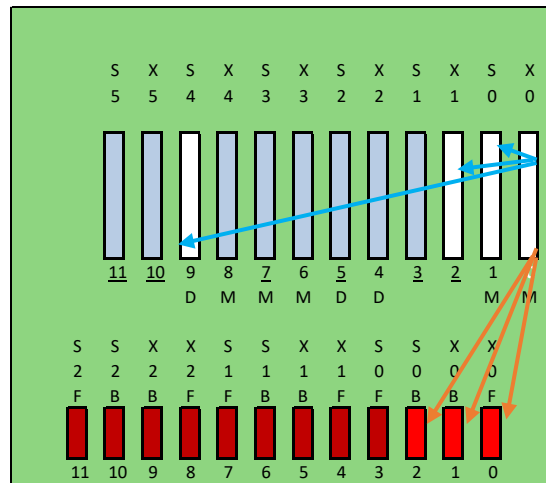
1. Relevant combined-MC/DC-board (DCB) slots and Pigtail (PT) slots

***Master and SCA are present on the underlined DCBs.**

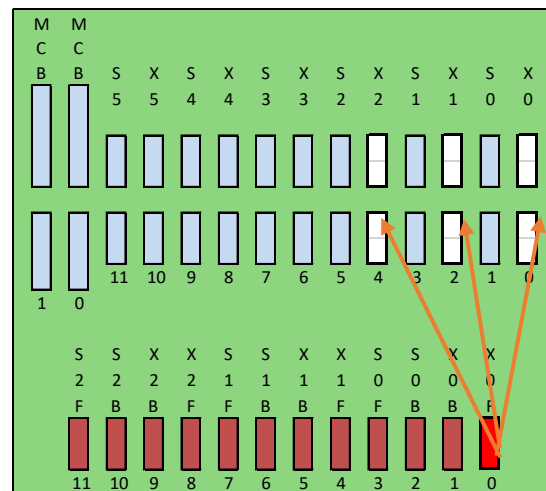
DCB(2,3) are now with GBTx-Tx's. DCB(4,5) are now with Master + SCA. The rest is identical to UT-Middle-backplane.

DCB:	<u>0</u>	<u>1</u>	2	3	<u>4</u>	<u>5</u>	6	7	8	9	<u>10</u>	11
PT:	0	1	2	3	4	5	6	7	8	9	10	11

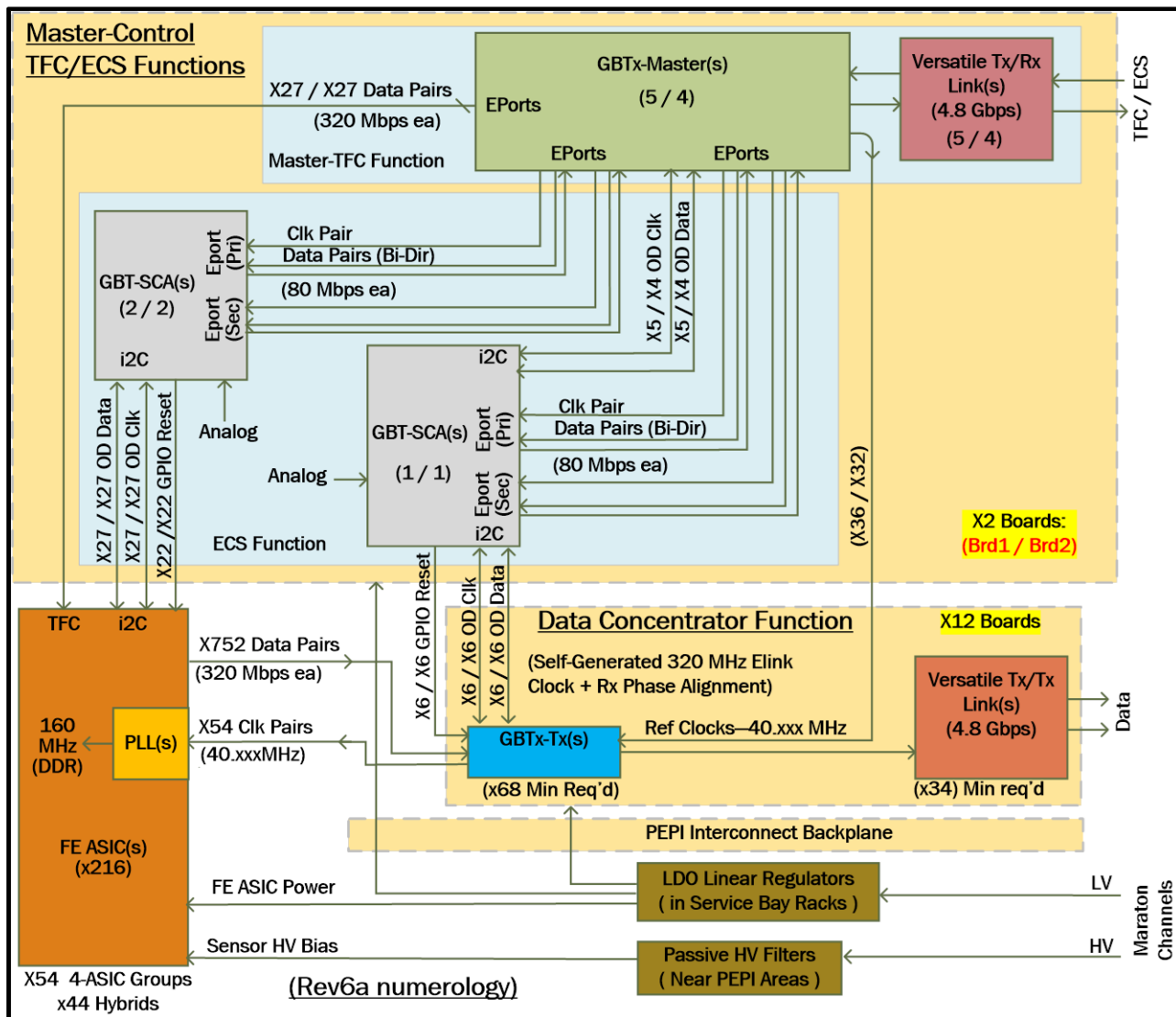
DCB to PT:



PT to DCB:



2. SEAM-pin name definitions



- DC#_ELK:**
Signal Elinks between GBTx-Tx DCs and FE ASICs
- MC_OUT_RCLK:**
Master control reference clock output for DCs
- DC_IN_RCLK:**
Master control reference clock input for DCs
- DC_OUT_RCLK:**
DC reference clock outputs for the Hybrids (always from DC0 on each DCB), from DC to Hybrids (on Pigtail)
- MC_TFC:**
Master control GBTx TFC for hybrids, from Master to Hybrids (on Pigtail)
- MC_SEC:**
Secondary ECS Elink from Master to control of GBT-SCA

- g. **EC_SEC:**
Secondary ECS Elink from SCA to be control by Master
- h. **EC_RESET_GPIO:**
ECS generated reset from SCA to DC and Hybrid. (Also available as general digital I/O)
- i. **DC_RESET:**
Reset common to all DC GBTx's, from SCA to DC
- j. **EC_HYB_i2C:**
ECS generated i2C bus for Hybrids (Data/CLK), from SCA to Hybrids
- k. **DC_i2C:**
ECS i2C bus for DCs, from DC to SCA
- l. **EC_DC_i2C:**
ECS i2C bus for DCs, from SCA to DC
- m. **EC_ADC:**
ADC inputs for ECS SCA, from SCA to DCB and Hybrid thermistors (NOTE: Use AGND as the signal reference.) Reserve _14 and _15 for V rails.
- n. **DC_Thermistor:**
Mounted on DCBs, leg _B connected to AGND
- o. **OM_Thermistor:**
Mounted on Optical Module mezzanine cards, leg _B connected to AGND

3. Mapping design rules

- **DC#_ELK**

- DCs are assigned according to Jason's **backplaneMapping_pigtailPins.xls** document.
- Column H assigns a "GBTx ID" to DCs (e.g., 00 – 1 is the 1st DC on DCB 00 / X-0).
- Columns E and G correspond to the PT slot and pin, mapping DC_ELK_CH to ASIC_CH
- The order of packing Elinks follows the **GBTx-DCB Eport Assignment** as shown below:

6.4 GBTx-DCB Eport Assignments (14 byte data frame using wide-bus mode)
An x ≡ Asic 'n', byte 'x' where 'x' = 0 ≡ LSB

Group	320 Mb/s GBTx Din Port ID	GBTx Frame Bits	Schematic Mnemonic	3 elink pack (4 ASICs)	4 elink pack (3 ASICs)	5 elink pack (2 ASICs)
5	Dio[5,1]	FRMUP[15:0]	ELK[1:0]	A0_1, A0_2 (MSB)	A0_2, A0_3 (MSB)	A0_3, A0_4 (MSB)
6	Dio[13,9]	FRMUP[31:16]	ELK[3:2]	A1_2 (MSB), A0_0 (LSB)	A0_0 (LSB), A0_1	A0_1, A0_2
0	Din[4,0]	FRMUP[47:32]	ELK[5:4]	A1_0 (LSB), A1_1	A1_2, A1_3 (MSB)	A1_4(MSB), A0_0 (LSB)
1	Din[12,8]	FRMUP[63:48]	ELK[7:6]	A2_1, A2_2 (MSB)	A1_0 (LSB), A1_1	A1_2, A1_3
2	Din[20,16]	FRMUP[79:64]	ELK[9:8]	A3_2 (MSB), A2_0 (LSB)	A2_2, A2_3 (MSB)	A1_0(LSB), A1_1
3	Din[28,24]	FRMUP[95:80]	ELK[11:10]	A3_0 (LSB), A3_1	A2_0 (LSB), A2_1	Fixed Val, Fixed Val
4	Din[36,32]	FRMUP[111:96]	ELK[13:12]	Fixed Val, Fixed Val	Fixed Val, Fixed Val	Fixed Val, Fixed Val

- The number of elinks per pack is determined by ASIC channels assigned on the corresponding **backplaneMapping_pigtailPins.xls** document.
- It goes like this (the 4th, the 5th...☺): the first ELK goes with the last channel on the ASIC, second ELK with the second last channel, and so on; Repeat for every ASIC.
- For unused Elinks due to 5-elink packing, PT pin = "N/A"; PT slot is the same as its siblings'. They are to be tied const to backplane.
- DCB 2/3 are present in the Inner case, from the blue-traced GBTx DCs on PT(0,1,2,3,4).

- DCB 10/11 were not present in the outer-backplane case, due to the absent outer stave. Correspondingly, PT 8/9/10/11 were not present in the outer-backplane case. For middle-backplane case, these are now added. They are the only difference between UTa-Outer and UT-Middle. DCB(9,10) are now with Master + SCA.

- **MC_OUT_RCLK & DC_IN_RCLK**

- Ref clocks provided by Master to DCs.
- Mapping scheme for DCB(0,1,4,5,6,7,8,9) with 5 Masters:
 - Have $8 \times 5 = 40$ MC_OUT_RCLK, from 5 Masters
 - Need to fill $6 \times 8 - (12) = 36$ DC_IN_RCLK, from 8 DCBs minus depop'd DCs
 - Ended up using all 40, including 4 depop'd (GBTx ID: 04-5, 05-2, 06-5, 07-2)
- Mapping scheme for DCB(9,10,11) with 2 Masters:
 - Have $8 \times 2 = 16$ MC_ from 2 Masters. Need $6 \times 2 = 12$ DC_ for DCB(10,11); and $2 \times 2 = 4$ depop'd on DCB(8,9). Number exactly matched.
- Mapping scheme for DCB(2,3,4,5) with 2 Masters:
 - Have 16 from 2 Masters. Need 12 for DCB(2,3). The depop'd DCs are all already mapped by the previous 2 schemes (12 DCs in total).

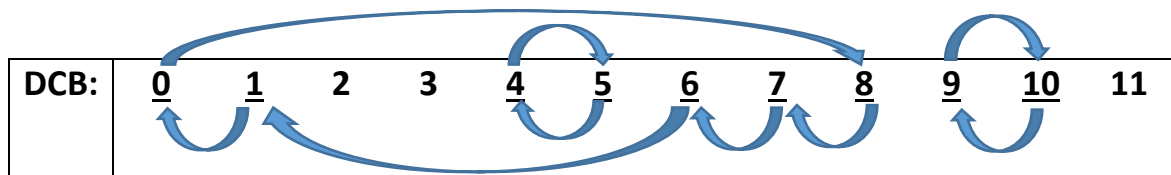
- **MC_TFC**

- TFC control from Master to Hybrids.
- Mapping scheme for DCB(0,1,4,5,6,7,8,9) :
 - Have $6 \times 5 = 30$ MC_TFC. Need $40 - 12$ (depop'd) = 28 for Hybrids on PT[00:07] (Inner-backplane Staves B+C). Used 28.
- Mapping scheme for DCB(9,10,11) :
 - Have $6 \times 2 = 12$. Need $4+3+3+4 = 14$ for Hybrids on PT[08:11].
 - Used all 12, **plus 2 previously unused from DCB(8)**.
- Mapping scheme for DCB(2,3,4,5) :
 - Have $6 \times 2 = 12$. Need 12 for depop'd Hybrids. Exactly matched.

- **MC_SEC & EC_SEC**

- Secondary ECS Elink for Master (MC_SEC) to control SCA (EC_SEC), the SCA being on a different DCB from the Master.
- Daisy-chain scheme:

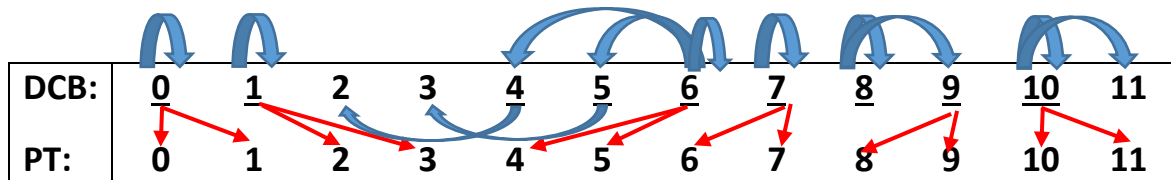
e.g., EC_SEC  MC_SEC



- **DC_OUT_RCLK**

- DC reference clock outputs for the Hybrids, from DCs to Hybrids.
- Mapping scheme for DCB(0,1,4,5,6,7,8,9) with 5 Masters:
 - Using the DC_OUT_RCLK's from DCBs that have Master/SCA: $8 \times 5 = 40$ available. Need $40 - 12$ (depop'd) = 28 for Hybrids. Used all 40 by including the 12 depop'd.
- Mapping for DCB(9,10,11) with 2 Masters:
 - Have $8 \times 2 = 16$ from 2 Masters; need $4 + 3 + 3 + 4 = 14$ from PT[8:11]. Used 14.
- Mapping scheme for DCB(2,3,4,5) :
 - None. All 12 depop'd have been mapped in the previous scheme.

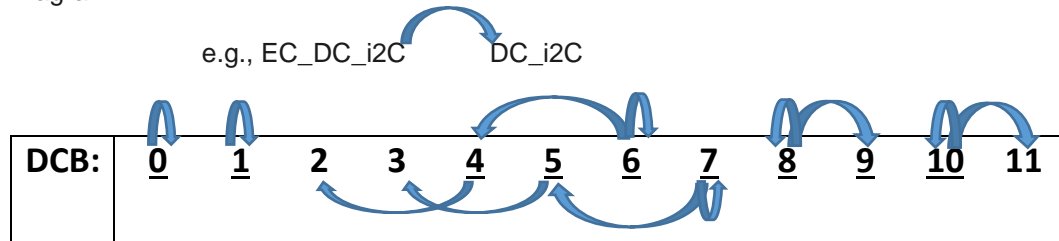
- **EC_RESET_GPIO, DC_RESET, and P#_RESET_P**
 - ECS generated reset from SCA to DC and Hybrid.
 - Mapping scheme for DCB(0,1,4,5,6,7,8,9) with 5 Masters:
 - Have $12 \times 5 = 60$ EC_RESET's from 5 SCAs
 - Need to be mapped to DC_RESET and P#_RESET_P (positive leg)
 - 8 DC_RESETs from 8 DCBs
 - All P#_RESET_Ps from PT[00:07]. (Including the depop'd since plenty of SCAs)
 - Mapping DCB(9,10,11) with 2 Masters:
 - Have $12 \times 2 = 24$
 - Need 2 for DC_ on DCB(10,11), and 14 for Hybrids on PT[8:11].
 - Mapping scheme for DCB(2,3,4,5) :
 - Need to map 2 DC_RESETs on DCB(2,3). Used 1 EC_RESET on each DCB(4,5).
 - Diagram: blue is to DCB; red is to Hybrids.



- **EC_HYB_i2C**
 - ECS generated i2C bus for Hybrids (Data/CLK), from SCA to Hybrids.
 - Hybrid channels on PT[00:07] are mapped to SCA channels on DCB(0, 1, 6).
 - PT[08:11] are now fully mapped to DCB(9).

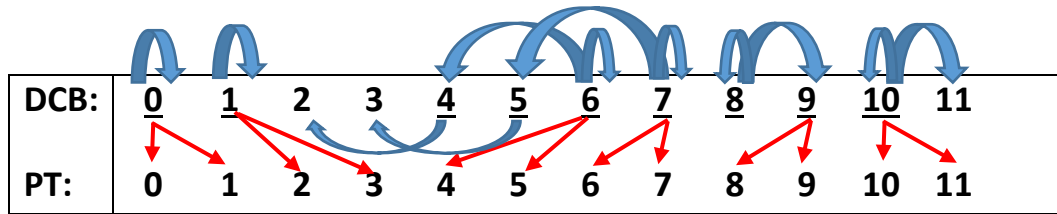
DCB:	<u>0</u>	<u>1</u>	<u>2</u>	<u>3</u>	<u>4</u>	<u>5</u>	<u>6</u>	<u>7</u>	<u>8</u>	<u>9</u>	<u>10</u>	<u>11</u>
PT:	0	1	2	3	4	5	6	7	8	9	10	11

- **DC_i2C & EC_DC_i2C**
 - ECS control i2C bus for DCs, between SCA and DC.
 - 1 DC_i2C per DCB, so 12 DC_i2C.
 - Diagram:



- **EC_ADC, DC_Thermistor, OM_Thermistor, (and 1V5 / 2V5 in the future)**
 - ADC inputs for SCA, from SCA to DCB or Hybrid thermistors (NOTE: Use AGND as the signal reference.) Reserve _14 and _15 for V rails.
 - *Thermistor_B* should always be connected to AGND (analog gnd); so should the PT pins that Nadim named *P#_THERMISTOR_N*.
 - *_P* should be paired with EC_ADC; *_N* with AGND. **But not any AGND: only the AGND from the same DCB as the EC_ADC.**
 - We reserve ADC[14:15] on each DCB for V rails (1V5, 2V5).
 - Have $14 \times 7 = 98$ ADC: from ADC[0:13] on 7 SCAs
 - For DCB(0,1,4,5,6,7,8,9,10,11), need $2 \times 10 + 54 = 74$.
 - 2 (DC+OM) from each DCB. 40 P#_THERMISTOR_P on PT[00:07]; 14 on PT[08:11].
 - For DCB(2,3), need $2 \times 2 = 4$. Used 2 EC_ADC on each DCB(4,5).

- Scheme: (Blue to DCB; red to PT)



- 1V5, 2V5, and GND
TBD.

UT Middle-backplane Mapping

Zishuo Yang

July 31, 2017

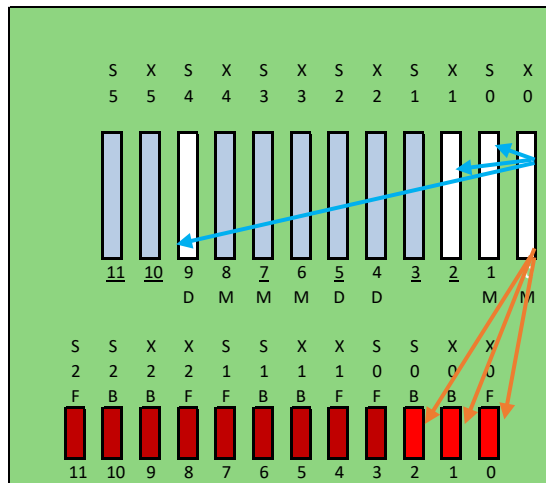
1. Relevant combined-MC/DC-board (DCB) slots and Pigtail (PT) slots

*Master and SCA are present on the underlined DCBs.

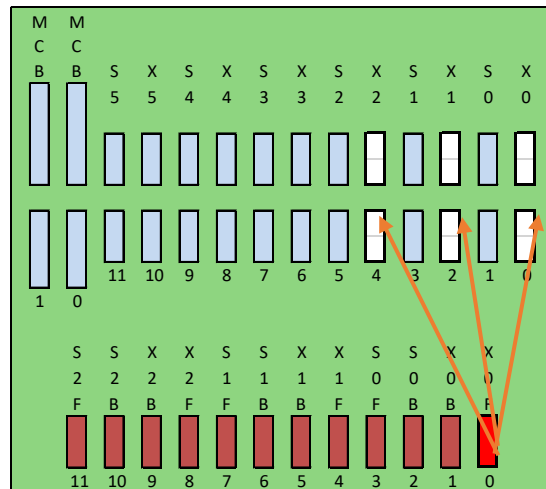
Dark red slots are the added mapping on top of UTa-Outer. The rest is identical to UTa-Outer. DCB(9,10) are now with Master + SCA.

DCB:	<u>0</u>	<u>1</u>	2	3	4	5	<u>6</u>	<u>7</u>	<u>8</u>	<u>9</u>	<u>10</u>	11
PT:	0	1	2	3	4	5	6	7	8	9	10	11

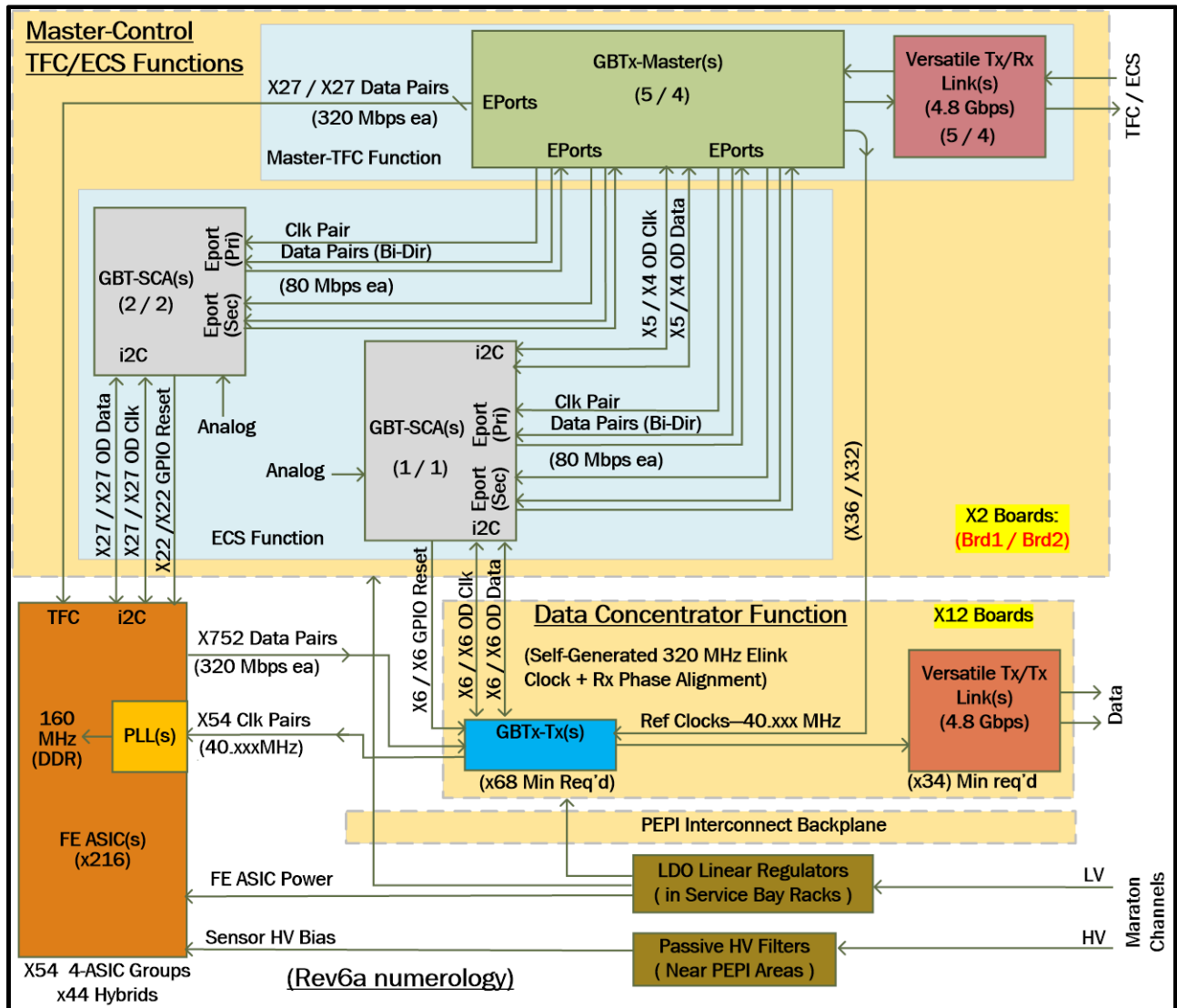
DCB to PT:



PT to DCB:



2. SEAM-pin name definitions



- a. **DC#_ELK:**
Signal Elinks between GBTx-Tx DCs and FE ASICs
- b. **MC_OUT_RCLK:**
Master control reference clock output for DCs
- c. **DC_IN_RCLK:**
Master control reference clock input for DCs
- d. **DC_OUT_RCLK:**
DC reference clock outputs for the Hybrids (always from DC0 on each DCB), from DC to Hybrids (on Pigtail)
- e. **MC_TFC:**
Master control GBTx TFC for hybrids, from Master to Hybrids (on Pigtail)
- f. **MC_SEC:**
Secondary ECS Elink from Master to control of GBT-SCA

- g. **EC_SEC:**
Secondary ECS Elink from SCA to be control by Master
- h. **EC_RESET_GPIO:**
ECS generated reset from SCA to DC and Hybrid. (Also available as general digital I/O)
- i. **DC_RESET:**
Reset common to all DC GBTx's, from SCA to DC
- j. **EC_HYB_i2C:**
ECS generated i2C bus for Hybrids (Data/CLK), from SCA to Hybrids
- k. **DC_i2C:**
ECS i2C bus for DCs, from DC to SCA
- l. **EC_DC_i2C:**
ECS i2C bus for DCs, from SCA to DC
- m. **EC_ADC:**
ADC inputs for ECS SCA, from SCA to DCB and Hybrid thermistors (NOTE: Use AGND as the signal reference.) Reserve _14 and _15 for V rails.
- n. **DC_Thermistor:**
Mounted on DCBs, leg _B connected to AGND
- o. **OM_Thermistor:**
Mounted on Optical Module mezzanine cards, leg _B connected to AGND

3. Mapping design rules

- **DC#_ELK**

- DCs are assigned according to Jason's **backplaneMapping_pigtailPins.xls** document.
- Column H assigns a "GBTx ID" to DCs (e.g., 00 – 1 is the 1st DC on DCB 00 / X-0).
- Columns E and G correspond to the PT slot and pin, mapping DC_ELK_CH to ASIC_CH
- The order of packing Elinks follows the **GBTx-DCB Eport Assignment** as shown below:

6.4 GBTx-DCB Eport Assignments (14 byte data frame using wide-bus mode)

An x ≡ Asic 'n', byte 'x' where 'x' = 0 ≡ LSB

Group	320 Mb/s GBTx Din Port ID	GBTx Frame Bit	Schematic Mnemonic	3 elink pack (4 ASICs)	4 elink pack (3 ASICs)	5 elink pack (2 ASICs)
5	Dio[5,1]	FRMUP[15:0]	ELK[1:0]	A0_1, A0_2 (MSB)	A0_2, A0_3 (MSB)	A0_3, A0_4 (MSB)
6	Dio[13,9]	FRMUP[31:16]	ELK[3:2]	A1_2 (MSB), A0_0 (LSB)	A0_0 (LSB), A0_1	A0_1, A0_2
0	Din[4,0]	FRMUP[47:32]	ELK[5:4]	A1_0 (LSB), A1_1	A1_2, A1_3 (MSB)	A1_4(MSB), A0_0 (LSB)
1	Din[12,8]	FRMUP[63:48]	ELK[7:6]	A2_1, A2_2 (MSB)	A1_0 (LSB), A1_1	A1_2, A1_3
2	Din[20,16]	FRMUP[79:64]	ELK[9:8]	A3_2 (MSB), A2_0 (LSB)	A2_2, A2_3 (MSB)	A1_0(LSB), A1_1
3	Din[28,24]	FRMUP[95:80]	ELK[11:10]	A3_0 (LSB), A3_1	A2_0 (LSB), A2_1	Fixed Val, Fixed Val
4	Din[36,32]	FRMUP[111:96]	ELK[13:12]	Fixed Val, Fixed Val	Fixed Val, Fixed Val	Fixed Val, Fixed Val

- The number of elinks per pack is determined by Jason's **backplaneMapping_pigtailPins.xls** document.
- It goes like this (the 4th, the 5th...☺): the first ELK goes with the last channel on the ASIC, second ELK with the second last channel, and so on; Repeat for every ASIC.
- For unused Elinks due to 5-elink packing, PT pin = "N/A"; PT slot is the same as its siblings'. They are to be tied const to backplane.
- DCB 2/3 are depopulated, from the blue-traced GBTx DCs on PT(0,1,2,3,4).

- DCB 10/11 were not present in the outer-backplane case, due to the absent outer stave. Correspondingly, PT 8/9/10/11 were not present in the outer-backplane case. **For middle-backplane case, these are now added. They are the only difference between UTa-Outer and UT-Middle. DCB(9,10) are now with Master + SCA.**

- **MC_OUT_RCLK & DC_IN_RCLK**

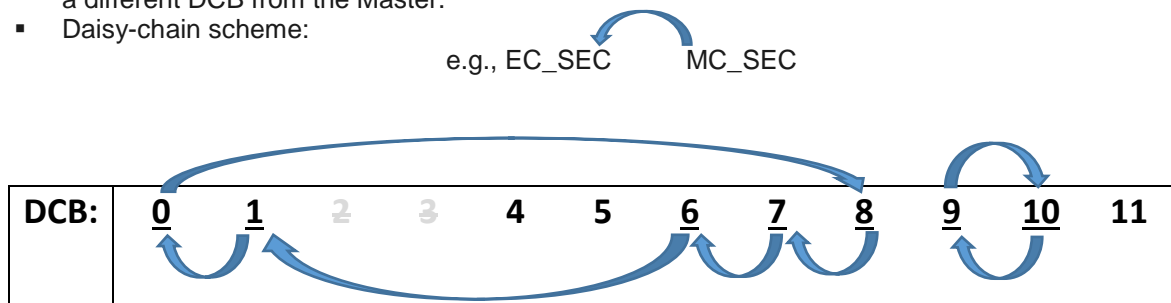
- Ref clocks provided by Master to DCs.
- Mapping scheme for 5 Masters on 8 DCBs:
 - Have $8 \times 5 = 40$ MC_OUT_RCLK, from 5 Masters
 - Need to fill $6 \times 8 - (12) = 36$ DC_IN_RCLK, from 8 DCBs minus depop'd DCs
 - Ended up using all 40, including 4 depop'd (GBTx ID: 04-5, 05-2, 06-5, 07-2)
- Mapping scheme for 2 Masters on 3 DCBs:
 - Have $8 \times 2 = 16$ MC_ from 2 Masters. Need $6 \times 2 = 12$ DC_ for DCB(10,11); and $2 \times 2 = 4$ depop'd on DCB(8,9). Number exactly matched.

- **MC_TFC**

- TFC control from Master to Hybrids.
- Mapping scheme for 5 Masters on 8 DCBs:
 - Have $6 \times 5 = 30$ MC_TFC. Need $40 - 12$ (depop'd) = 28 for Hybrids on PT[00:07]. Used 28.
- Mapping scheme for DCB[9:11]:
 - Have $6 \times 2 = 12$. Need $4+3+3+4 = 14$ for Hybrids on PT[08:11].
 - Used all 12, **plus 2 previously unused from DCB(8).**

- **MC_SEC & EC_SEC**

- Secondary ECS Elink for Master (MC_SEC) to control SCA (EC_SEC), the SCA being on a different DCB from the Master.
- Daisy-chain scheme:



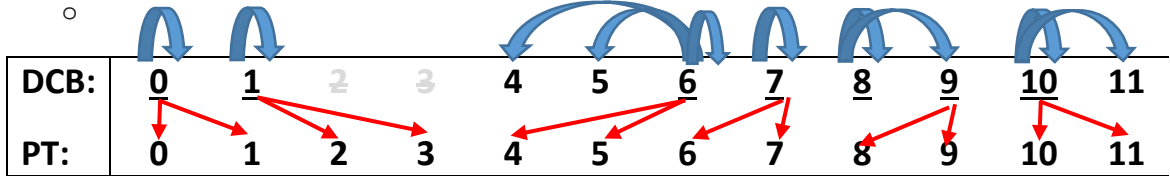
- **DC_OUT_RCLK**

- DC reference clock outputs for the Hybrids, from DCs to Hybrids.
- Mapping scheme for 5 Masters on 8 DCBs:
 - Using the DC_OUT_RCLK's from DCBs that have Master/SCA: $8 \times 5 = 40$ available. Need $40 - 12$ (depop'd) = 28 for Hybrids. Used all 40 by including the 12 depop'd.
- Mapping for DCB[9:11]:
 - Have $8 \times 2 = 16$ from 2 Masters; need $4 + 3 + 3 + 4 = 14$ from PT[8:11]. Used 14.

- **EC_RESET_GPIO, DC_RESET, and P#_RESET_P**

- ECS generated reset from SCA to DC and Hybrid.
- Mapping scheme for the 8 DCBs:
 - Have $12 \times 5 = 60$ EC_RESET's from 5 SCAs
 - Need to be mapped to DC_RESET and P#_RESET_P (positive leg)
 - 8 DC_RESETs from 8 DCBs
 - All P#_RESET_Ps from PT[00:07]. (Including the depop'd since plenty of SCAs)

- Mapping DCB[9:11]:
 - Have $12 \times 2 = 24$
 - Need 2 for DC_ on DCB(10,11), and 14 for Hybrids on PT[8:11].
 - Diagram: blue is to DCB; red is to Hybrids.



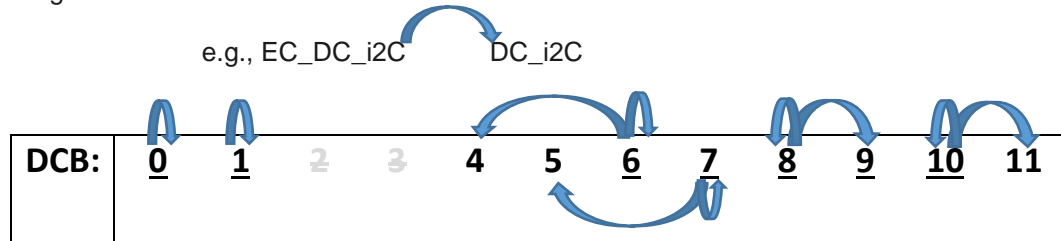
- EC_HYB_i2C**

- ECS generated i2C bus for Hybrids (Data/CLK), from SCA to Hybrids.
- Hybrid channels on PT[00:07] are mapped to SCA channels on DCB(0, 1, 6).
- PT[08:11] are now fully mapped to DCB(9).



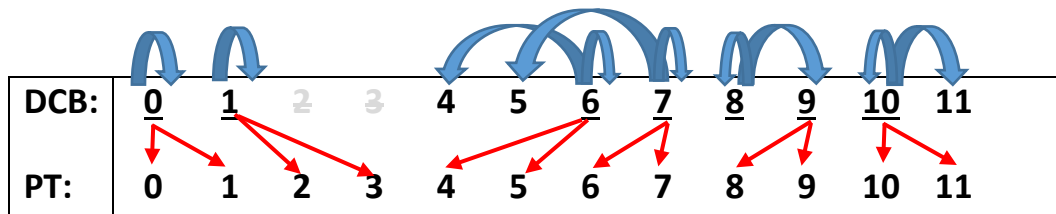
- DC_i2C & EC_DC_i2C**

- ECS control i2C bus for DCs, between SCA and DC.
- 1 DC_i2C per DCB, so 10 DC_i2C.
- 2 EC_DC_i2C per DCB w/ SCA, so 14 EC_.
- Diagram:



- EC_ADC, DC_Thermistor, OM_Thermistor, (and 1V5 / 2V5 in the future)**

- ADC inputs for SCA, from SCA to DCB or Hybrid thermistors (NOTE: Use AGND as the signal reference.) Reserve _14 and _15 for V rails.
- Thermistor_B* should always be connected to AGND (analog gnd); so should the PT pins that Nadim named *P#_THERMISTOR_N*.
- _P should be paired with EC_ADC; _N with AGND. **But not any AGND: only the AGND from the same DCB as the EC_ADC.**
- We reserve ADC[14:15] on each DCB for V rails (1V5, 2V5).
- Have $14 \times 7 = 98$ ADC: from ADC[0:13] on 7 SCAs
- Need $2 \times 10 + 54 = 74$.
 - 2 (DC+OM) from each DCB. 40 P#_THERMISTOR_P on PT[00:07]; 14 on PT[08:11].
- Scheme: (Blue to DCB; red to PT)



- **1V5, 2V5, and GND**
TBD.

UT Detector-plane-a Outer-backplane Mapping

Zishuo Yang

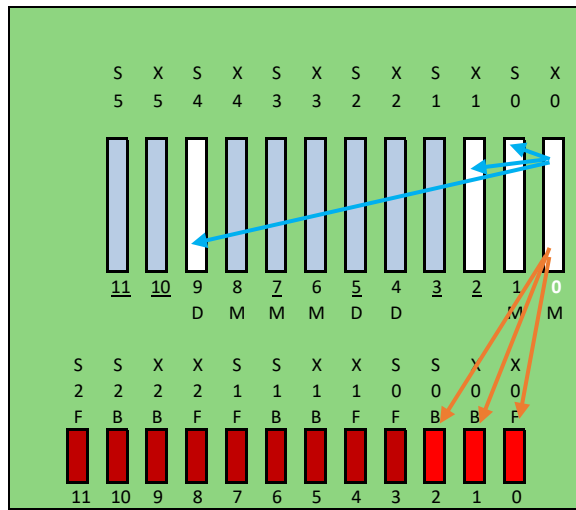
July 25, 2017

1. Relevant combined-MC/DC-board (DCB) slots and Pigtail (PT) slots

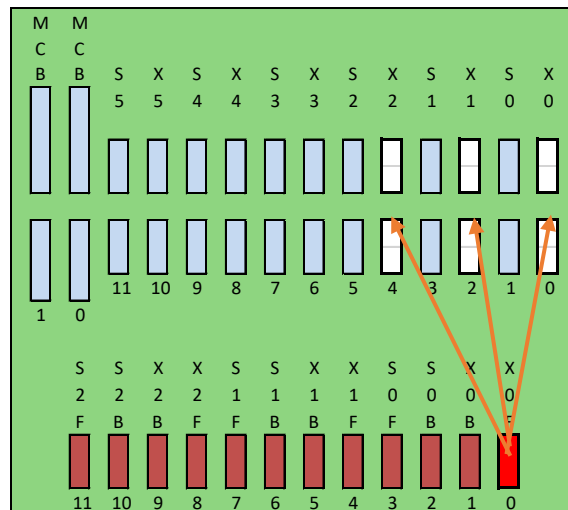
*Master and SCA are present on the underlined DCBs.

DCB:	<u>0</u>	<u>1</u>	2	3	4	5	<u>6</u>	<u>7</u>	<u>8</u>	9	10	11
PT:	0	1	2	3	4	5	6	7	8	9	10	11

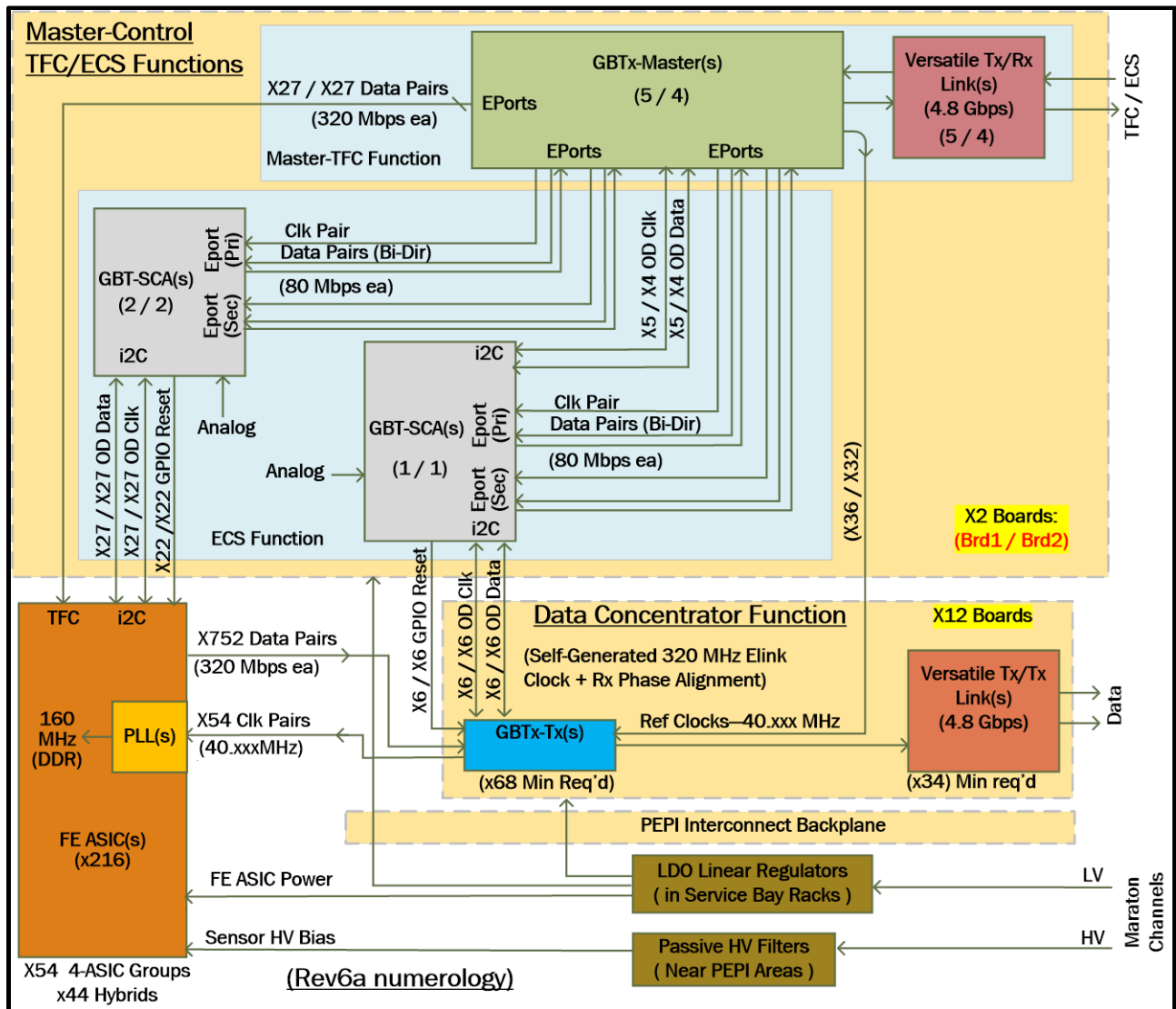
DCB to PT:



PT to DCB:



2. SEAM-pin name definitions



- a. **DC#_ELK:**
Signal Elinks between GBTx-Tx DCs and FE ASICs
- b. **MC_OUT_RCLK:**
Master control reference clock output for DCs
- c. **DC_IN_RCLK:**
Master control reference clock input for DCs
- d. **DC_OUT_RCLK:**
DC reference clock outputs for the Hybrids (always from DC0 on each DCB), from DC to Hybrids (on Pigtail)
- e. **MC_TFC:**
Master control GBTx TFC for hybrids, from Master to Hybrids (on Pigtail)
- f. **MC_SEC:**
Secondary ECS Elink from Master to control of GBTx-SCA
- g. **EC_SEC:**
Secondary ECS Elink from SCA to be control by Master

- h. **EC_RESET_GPIO:**
ECS generated reset from SCA to DC and Hybrid. (Also available as general digital I/O)
- i. **DC_RESET:**
Reset common to all DC GBTx's, from SCA to DC
- j. **EC_HYB_i2C:**
ECS generated i2C bus for Hybrids (Data/CLK), from SCA to Hybrids
- k. **DC_i2C:**
ECS i2C bus for DCs, from DC to SCA
- l. **EC_DC_i2C:**
ECS i2C bus for DCs, from SCA to DC
- m. **EC_ADC:**
ADC inputs for ECS SCA, from SCA to DCB and Hybrid thermistors (NOTE: Use AGND as the signal reference.) Reserve _14 and _15 for V rails.
- n. **DC_Thermistor:**
Mounted on DCBs, leg _B connected to AGND
- o. **OM_Thermistor:**
Mounted on Optical Module mezzanine cards, leg _B connected to AGND

3. Mapping design rules

- **DC#_ELK**

- DCs are assigned according to Jason's *backplaneMapping_pigtailPins.xls* document.
- Column H assigns a "GBTx ID" to DCs (e.g., 00 – 1 is the 1st DC on DCB 00 / X-0).
- Columns E and G correspond to the PT slot and pin, mapping DC_ELK_CH to ASIC_CH
- The order of packing Elinks follows the **GBTx-DCB Eport Assignment** as shown below:

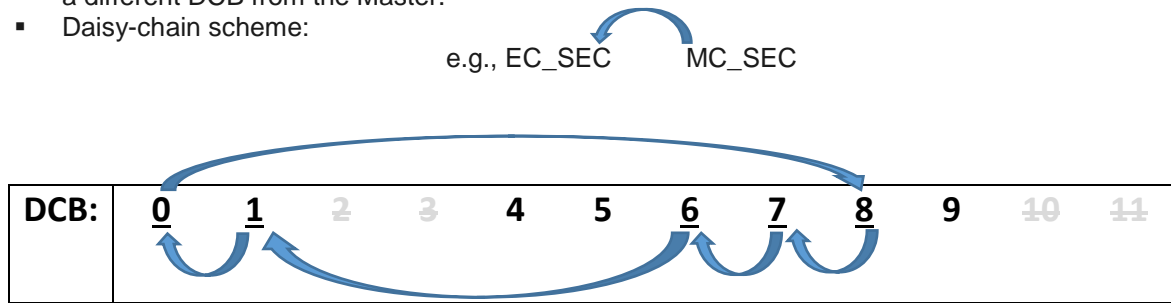
6.4 GBTx-DCB Eport Assignments (14 byte data frame using wide-bus mode)

An x ≡ ASIC 'n', byte 'x' where 'x' = 0 ≡ LSB

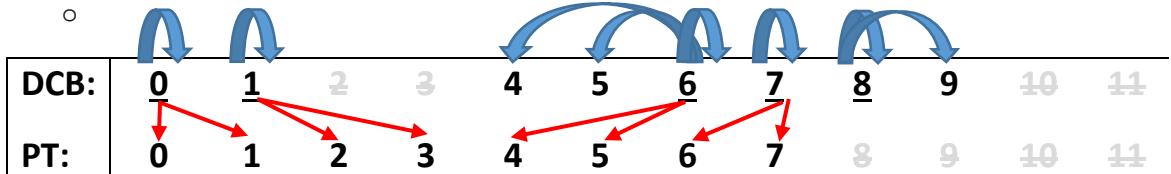
Group	320 Mb/s GBTx Din Port ID	GBTx Frame Bit	Schematic Mnemonic	3 elink pack (4 ASICs)	4 elink pack (3 ASICs)	5 elink pack (2 ASICs)
5	Dio[5,1]	FRMUP[15:0]	ELK[1:0]	A0_1, A0_2 (MSB)	A0_2, A0_3 (MSB)	A0_3, A0_4 (MSB)
6	Dio[13,9]	FRMUP[31:16]	ELK[3:2]	A1_2 (MSB), A0_0 (LSB)	A0_0 (LSB), A0_1	A0_1, A0_2
0	Din[4,0]	FRMUP[47:32]	ELK[5:4]	A1_0 (LSB), A1_1	A1_2, A1_3 (MSB)	A1_4(MSB), A0_0 (LSB)
1	Din[12,8]	FRMUP[63:48]	ELK[7:6]	A2_1, A2_2 (MSB)	A1_0 (LSB), A1_1	A1_2, A1_3
2	Din[20,16]	FRMUP[79:64]	ELK[9:8]	A3_2 (MSB), A2_0 (LSB)	A2_2, A2_3 (MSB)	A1_0(LSB), A1_1
3	Din[28,24]	FRMUP[95:80]	ELK[11:10]	A3_0 (LSB), A3_1	A2_0 (LSB), A2_1	Fixed Val, Fixed Val
4	Din[36,32]	FRMUP[111:96]	ELK[13:12]	Fixed Val, Fixed Val	Fixed Val, Fixed Val	Fixed Val, Fixed Val

- The number of elinks per pack is determined by Jason's *backplaneMapping_pigtailPins.xls* document.
- It goes like this (the 4th, the 5th...☺): the first ELK goes with the last channel on the ASIC, second ELK with the second last channel, and so on; Repeat for every ASIC.
- For unused Elinks due to 5-elink packing, PT pin = "N/A"; PT slot is the same as its siblings'. They are to be tied const to backplane.
- DCB 2/3 are depopulated, from the blue-traced GBTx DCs on PT 0/1/2/3.

- DCB 10/11 are not present in the outer-backplane case, due to the absent outer stave. Correspondingly, PT 8/9/10/11 are not present in the outer-backplane case, neither. [TO BE DOUBLE-CHECKED].
- **MC_OUT_RCLK & DC_IN_RCLK**
 - Ref clocks provided by Master to DCs.
 - Mapping scheme for 5 Masters on 8 DCBs:
 - Have $8 \times 5 = 40$ MC_OUT_RCLK, from 5 Masters
 - Need to fill $6 \times 8 - (12) = 36$ DC_IN_RCLK, from 8 DCBs minus depop'd DCs
 - Ended up using all 40, including 4 depop'd (GBTx ID: 04-5, 05-2, 06-5, 07-2)
- **MC_TFC**
 - TFC control from Master to Hybrids.
 - Mapping scheme for 5 Masters on 8 DCBs:
 - Have $6 \times 5 = 30$ MC_TFC
 - Need $40 - 12$ (depop'd) = 28 for Hybrids on PT[00:07]
 - Used 28
- **MC_SEC & EC_SEC**
 - Secondary ECS Elink for Master (MC_SEC) to control SCA (EC_SEC), the SCA being on a different DCB from the Master.
 - Daisy-chain scheme:



- **DC_OUT_RCLK**
 - DC reference clock outputs for the Hybrids, from DCs to Hybrids.
 - Using the DC_OUT_RCLK's from DCBs that have Master/SCA: $8 \times 5 = 40$ available
 - Need $40 - 12$ (depop'd) = 28 for Hybrids
 - Used all 40 by including the 12 depop'd
- **EC_RESET_GPIO, DC_RESET, and P#_RESET_P**
 - ECS generated reset from SCA to DC and Hybrid.
 - Have $12 \times 5 = 60$ EC_RESET's from 5 SCAs
 - Need to be mapped to DC_RESET and P#_RESET_P (positive leg)
 - 8 DC_RESETs from 8 DCBs
 - All P#_RESET_Ps from PT[00:07]. (Including the depop'd since plenty of SCAs)
 - Scheme: (Blue is to DCB; Red is to Hybrids)
 -

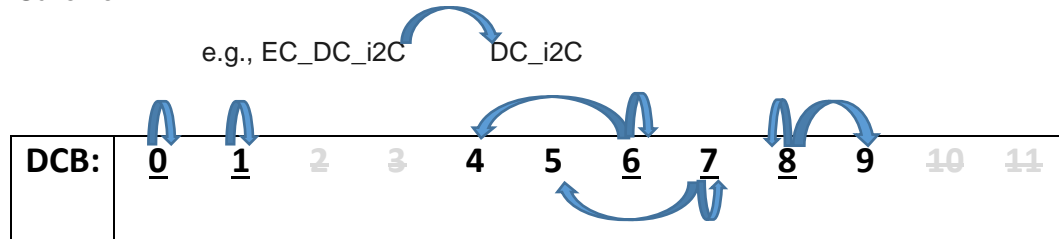


- **EC_HYB_i2C**
 - ECS generated i2C bus for Hybrids (Data/CLK), from SCA to Hybrids.
 - Hybrid channels on PT[00:07] are mapped to SCA channels on DCB(0, 1, 6).
 - For future mapping, PT[08:11] are currently mapped to DCB(9). But this doesn't concern the outer-backplane case.

DCB:	<u>0</u>	<u>1</u>	2	3	4	5	<u>6</u>	<u>7</u>	<u>8</u>	9	10	11
PT:	0	1	2	3	4	5	6	7	8	9	10	11

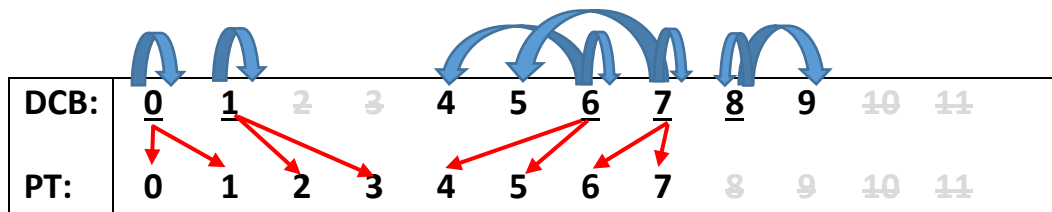
- **DC_i2C & EC_DC_i2C**

- ECS control i2C bus for DCs, between SCA and DC.
- 1 DC_i2C per DCB, so 8; 2 EC_DC_i2C per DCB w/ SCA, so 10.
- Scheme:



- **EC_ADC, DC_Thermistor, OM_Thermistor, (and 1V5 / 2V5 in the future)**

- ADC inputs for SCA, from SCA to DCB or Hybrid thermistors (NOTE: Use AGND as the signal reference.) Reserve _14 and _15 for V rails.
- *Thermistor_B* should always be connected to AGND (analog gnd); so should the PT pins that Nadim named *P#_THERMISTOR_N*.
- *_P* should be paired with EC_ADC; *_N* with AGND. **But not any AGND: only the AGND from the same DCB as the EC_ADC.**
- We reserve ADC[14:15] on each DCB for V rails (1V5, 2V5).
- Have 14 x 5 = 70 ADC: from ADC[0:13] on 5 SCAs
- Need 2 x 8 + 40 = 56.
 - 2 (DC+OM) from each DCB; 40 P#_THERMISTOR_P on PT[00:07]
- Scheme: (Blue to DCB; red to PT)



- **1V5, 2V5, and GND: TBD**